DOCKET NO: 251428US40

EXPEDITED PROCEDURE EXAMINING

IN THE UNITED

IN RE APPLICATION OF MASAKATSU MAEDA

: EXAMINER: FEELY, MICHAEL J

Do Not Enter MF 4/18/07

SERIAL NO: 10/821,852

FILED: APRIL 12, 2004

: GROUP ART UNIT: 1712

FOR: EPOXY RESIN COMPOSITION FOR SEMICONDUCTOR SEALING AND

SEMICONDUCTOR DEVICE

AMENDMENT UNDER 37 C.F.R. § 1.116

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated March 22, 2007, please amend the aboveidentified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.